



74AHC1G126Q

SINGLE BUFFER GATE WITH 3-STATE OUTPUT

Description

The DIODES 74AHC1G126Q is an automotive compliant single noninverting buffer/bus driver with a 3-state output. The output enters a high impedance state when a LOW-level is applied to the output enable (OE) pin. The device is designed for operation with a power supply range of 2.0V to 5.5V.

Pin Assignments



Features

- Grade 1 Ambient Temperature Operation: -40°C to +125°C
- Supply Voltage Range from 2.0V to 5.5V
- ±8mA Output Drive at 4.5V
- **CMOS Low-Power Consumption**
- Schmitt Trigger Action at All Inputs Makes the Circuit Tolerant for Slower Input Rise and Fall Time
- Inputs Not Limited by Vcc
- **Balanced Propagation Delays**
- **Balanced Drive Capability**
- ESD Protection Tested per AEC-Q100
- Exceeds 2000-V Human Body Model (AEC-Q100-002)
- Exceeds 1000-V Charged Device Model (AEC-Q100-011)
- Latchup Exceeds 100mA (AEC-Q100-004)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The 74AHC1G126Q is suitable for automotive applications requiring specific change control; this part is AEC-Q100 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Applications

- General purpose logic •
- Wide array of products, such as:
 - Automotive applications within Grade 1 temperature range
 - Industrial computing/controls/automation
 - High reliability networking/communications
 - Industrial/agricultural equipment



Pin Descriptions

•	
Pin Name	Description
OE	Output Enable
A	Data Input
GND	Ground
Y	Data Output
Vcc	Supply Voltage

Logic Diagram



Function Table

In	Inputs			
OE	A	Y		
Н	Н	Н		
Н	L	L		
L	X	Z		

Absolute Maximum Ratings (Notes 4 & 5)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
Vcc	Supply Voltage Range	-0.5 to 6.5	V
Vı	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage Applied to Output in High or Low State	-0.5 to Vcc + 0.5	V
l _{IK}	Input Clamp Current VI < 0	-20	mA
Іок	Output Clamp Current (Vo < 0 or Vo > Vcc)	±20	mA
lo	Continuous Output Current (Vo = 0 to Vcc)	±25	mA
Icc	Continuous Current Through V _{CC}	75	mA
Ignd	Continuous Current Through GND	-75	mA
TJ	Operating Junction Temperature	-40 to +150	°C
TSTG	Storage Temperature	-65 to +150	°C
PD	Total Power Dissipation (Note 6)	250	mW

4. Stresses greater than those listed under Absolute Maximum Ratings can cause permanent damage to the device. These are stress ratings only, and Notes: functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability. 5. Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a

condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.

6. This will need to be derated at higher operating temperatures to prevent exceeding maximum TJ. Refer to Package Characteristics section.



Recommended Operating Conditions (Note 7)

Symbol	Paramet	er	Min	Max	Unit	
Vcc	Operating Voltage	—	2	5.5	V	
		Vcc = 2V	1.5	—		
Vін	High-Level Input Voltage	Vcc = 3V	2.1	—	V	
		Vcc = 5.5V	3.85	—		
		$V_{CC} = 2V$	—	0.5		
VIL	Low-Level Input Voltage	Vcc = 3V	—	0.9	V	
		Vcc = 5.5V	_	1.65		
VI	Input Voltage	0	5.5	V		
Vo	Output Voltage		0	Vcc	V	
		Vcc = 2V	_	-50	μA	
Іон	High-Level Output Current	$V_{CC} = 3.3V \pm 0.3V$	_	-4	mA	
		$V_{CC} = 5V \pm 0.5V$	—	-8	IIIA	
		Vcc = 2V	—	50	μA	
IOL	Low-Level Output Current	$V_{CC} = 3.3V \pm 0.3V$	_	4	~ ^	
		$V_{CC} = 5V \pm 0.5V$	_	8	mA	
Δt/ΔV	Input Transition Pige or Foll Pote	$V_{CC} = 3.3V \pm 0.3V$	—	100	DO //	
ΔυΔν	Input Transition Rise or Fall Rate	$V_{CC} = 5V \pm 0.5V$	—	20	ns/V	
TA	Operating Free-Air Temperature	_	-40	+125	°C	

Note: 7. Unused inputs should be held at V_{CC} or Ground.

	-	-			+25°C		-40°C to	o +85°C	-40°C to	+125°C		
Symbol	I Parameter	Test Conditions	Vcc	Min	Тур	Max	Min	Max	Min	Max	Unit	
			2V	1.9	2	_	1.9		1.9			
		VI = VIH or VIL IOH = -50µA	3V	2.9	3		2.9	_	2.9	—		
Vон	High Level Output	Level Output	4.5V	4.4	4.5		4.4	_	4.4		V	
∨ОН	Voltage	VI = VIH or VIL IOH = -4mA	3V	2.58		_	2.48	_	2.40	_	v	
		VI = VIH or VIL I _{OH} = -8mA	4.5V	3.94			3.8	_	3.70	—		
			2V			0.1		0.1	_	0.1		
				3V			0.1		0.1	_	0.1	
Vol	Low Level Output		4.5V			0.1	-	0.1	_	0.1	V	
VOL	Voltage	VI = VIH or VIL IOL = 4mA	3V	_		0.36		0.44	_	0.55	v	
		$V_I = V_{IH} \text{ or } V_{IL}$ IoL = 8mA	4.5V			0.36		0.44	—	0.55		
loz	Z State Leakage Current	$V_1 = 5.5V$ or GND $V_0 = 0$ to 5.5V	5.5V	_	_	0.25	_	2.5	_	10	μΑ	
h	Input Current	VI = 5.5V or GND	0 to 5.5V			±0.1		±1	_	±2	μA	
Icc	Supply Current	$V_I = 5.5V \text{ or GND}$ $I_O = 0$	5.5V			1		10	_	40	μΑ	
Cı	Input Capacitance	VI = VCC or GND	5.5V	_	2.0	10	_	10	_	10	pF	

Electrical Characteristics (All typical values are at V_{CC} = 3.3V, T_A = +25°C.)



Package Characteristics

Symbol	Parameter	Package	Test Conditions	Min	Тур	Max	Unit
0	θ _{JA} Thermal Resistance Junction-to-Ambient	SOT25	(Note 9)	_	184	—	°C/W
ÐJA		SOT353	(Note 8)	_	385	_	
0	Thermal Resistance	SOT25	(Nata O)	_	62	_	90AM
θις	Junction-to-Case	SOT353	(Note 8)		164	—	°C/W

Note: 8. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Switching Characteristics

Vcc = 3.3V ± 0.3V (See Figure 1)

Deremeter	From	From To			+25°C		-40°C to +85°C		-40°C to +125°C		Unit
Parameter (In	(Input)	(Output)	Conditions	Min	Тур	Max	Min	Max	Min	Max	Unit
4	^	A Y	CL = 15pF	1.0	4.7	8.0	1.0	9.5	1.0	11.5	ns
tpd	A		$C_L = 50 pF$	1.0	6.6	11.5	1.0	13.0	1.0	14.5	ns
4	ten OE	Y	CL = 15pF	1.0	5.0	8.0	1.0	9.5	1.0	11.5	ns
ten	UE	Т	$C_L = 50 pF$	1.0	6.9	11.5	1.0	13.0	1.0	14.5	ns
tava	OE	OF Y	C _L = 15pF	1.0	6.0	9.7	1.0	11.5	1.0	12.5	ns
tDIS	UE	Т	$C_L = 50 pF$	1.0	8.3	13.2	1.0	15.0	1.0	16.5	ns

Vcc = 5V ± 0.5V (See Figure 1)

Deveneter	From	-	Test	+25°C		-40°C to +85°C		-40°C to +125°C		Unit	
Parameter (In	(Input)		Conditions	Min	Тур	Max	Min	Max	Min	Max	Unit
4	A Y	CL = 15pF	1.0	3.4	5.5	1.0	6.5	1.0	7.0	ns	
tpD		A Y	$C_L = 50 pF$	1.0	4.8	7.5	1.0	8.5	1.0	9.5	ns
4	OE	V	C _L = 15pF	1.0	3.6	5.1	1.0	6.0	1.0	6.5	ns
ten	UE	ř	CL = 50pF	1.0	4.9	7.5	1.0	8.5	1.0	9.5	ns
4	OF V	CL = 15pF	1.0	4.1	6.8	1.0	8.0	1.0	8.5	ns	
tDIS	OE	Ŷ	$C_L = 50 pF$	1.0	5.7	8.8	1.0	10.0	1.0	11.0	ns

Operating Characteristics

TA = +25°C

Parameter		Test	Vcc = 5V	Unit
		Conditions	Тур	Onit
CPD	Power Dissipation Capacitance	f = 1MHz No Load	10	pF



Measurement Information



Test	S1
tplh/tphl	Open
tplz/tpzl	V _{LOAD}
tphz/tpzh	GND

Vee	Inp	uts	VM	C.	VA	
Vcc	Vı	tr/tr	VМ	C∟	٧A	
3.3V±0.3V	Vcc	≤ 3ns	Vcc/2	15pF	0.3V	
5V±0.5V	Vcc	≤ 3ns	Vcc/2	15pF	0.3V	
3.3V±0.3V	Vcc	≤ 3ns	V _{CC} /2	50pF	0.3V	
5V±0.5V	V _{CC}	≤ 3ns	V _{CC} /2	50pF	0.3V	



Voltage Waveform Pulse Duration







Voltage Waveform Enable and Disable Time Low and High Level Enabling

Figure 1. Load Circuit and Voltage Waveforms

A. Includes test lead and test apparatus capacitance. B. All pulses are supplied at pulse repetition rate \leq 1MHz. Notes:

- C. Inputs are measured separately one transition per measurement.
- D. t_{PLZ} and t_{PHZ} are the same as t_{DIS} .
- E. t_{PZL} and t_{PZH} are the same as t_{EN} .
- F. t_{PLH} and t_{PHL} are the same as t_{PD} .



Ordering Information (Note 9)



Part Number Part Numb		Paakaga Cada	Package	Package Size	Packing		
Fart Number	Suffix	Package Code	(Notes 10 & 11)	Fackage Size	Qty.	Carrier	
74AHC1G126QSE-7	-7	SE	SOT353	2.15mm x 2.1mm x 1.1mm 0.65mm lead pitch	3000	Tape & Reel	
74AHC1G126QW5-7	-7	W5	SOT25	3.0mm x 2.8mm x 1.2mm 0.95mm lead pitch	3000	Tape & Reel	

Notes: 9. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

10. Pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/packageoutlines.html.

11. The taping orientation is located on our website at https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf.

Marking Information



SOT 25 / SOT 353

Part Number	Package	Identification Code
74AHC1G126QW5-7	SOT25	YZQ
74AHC1G126QSE-7	SOT353	YZQ



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SOT25



SOT25				
Dim	Min	Max	Тур	
Α	0.35	0.50	0.38	
В	1.50	1.70	1.60	
С	2.70	3.00	2.80	
D	-	-	0.95	
Н	2.90	3.10	3.00	
J	0.013	0.10	0.05	
К	1.00	1.30	1.10	
L	0.35	0.55	0.40	
Μ	0.10	0.20	0.15	
Ν	0.70	0.80	0.75	
α	0°	8°	-	
All Dimensions in mm				

(2) Package Type: SOT353



SOT353					
Dim	Min	Max	Тур		
A1	0.00	0.10	0.05		
A2	0.90	1.00	0.95		
b	0.10	0.30	0.25		
С	0.10	0.22	0.11		
D	1.80	2.20	2.15		
Е	2.00	2.20	2.10		
E1	1.15	1.35	1.30		
e	0.650 BSC				
F	0.40	0.45	0.425		
L	0.25	0.40	0.30		
а	0°	8°			
All Dimensions in mm					



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SOT25



Value (in mm) Z 3.20 G 1.60 X 0.55 Y 0.80 C1 2.40 C2 0.95

(2) Package Type: SOT353



Dimensions	Value (in mm)
С	0.650
C1	1.900
G	1.300
Х	0.420
X1	1.720
Ŷ	0.600
Y1	2.500

Mechanical Data

SOT25

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 3
- Weight: 0.0158 grams (Approximate)

SOT353

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 3
- Weight: 0.0064 grams (Approximate)



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